



STD65N3LLH5 STU65N3LLH5

N-channel 30 V, 0.0061 Ω , 65 A, DPAK, IPAK
STripFET™ V Power MOSFET

Features

| Type | V _{DSS} | R _{DS(on)} max | I _D |
|-------------|------------------|-------------------------|----------------|
| STD65N3LLH5 | 30 V | 0.0069 Ω | 65 A |
| STU65N3LLH5 | 30 V | 0.0073 Ω | 65 A |

- R_{DS(on)} * Q_g industry benchmark
- Extremely low on-resistance R_{DS(on)}
- Very low switching gate charge
- High avalanche ruggedness
- Low gate drive power losses

Application

Switching applications

Description

This STripFET™V Power MOSFET technology is among the latest improvements, which have been especially tailored to achieve very low on-state resistance providing also one of the best-in-class figure of merit.

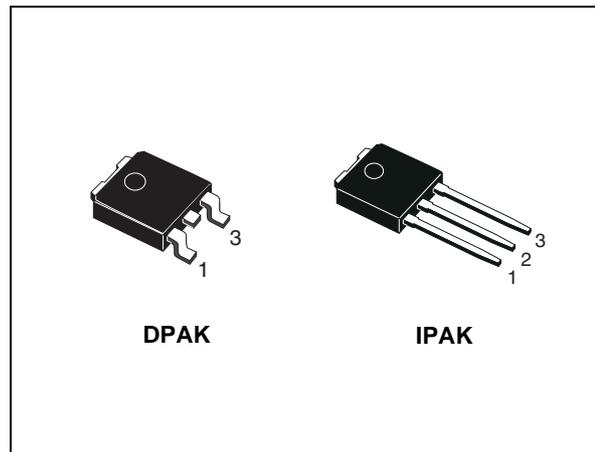


Figure 1. Internal schematic diagram

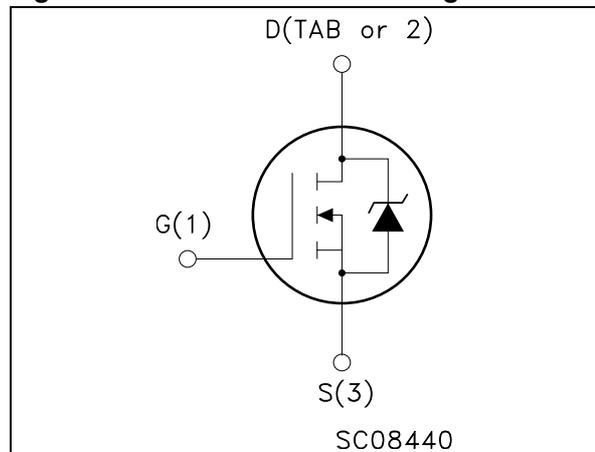


Table 1. Device summary

| Order code | Marking | Package | Packaging |
|-------------|----------|---------|---------------|
| STD65N3LLH5 | 65N3LLH5 | DPAK | Tape and reel |
| STU65N3LLH5 | 65N3LLH5 | IPAK | Tube |

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1 Electrical ratings

Table 2. Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|--------------------|---|------------|---------------------|
| V_{DS} | Drain-source voltage ($V_{GS}=0$) | 30 | V |
| V_{GS} | Gate-source voltage | ± 22 | V |
| I_D | Drain current (continuous) at $T_C = 25\text{ }^\circ\text{C}$ | 65 | A |
| I_D | Drain current (continuous) at $T_C = 100\text{ }^\circ\text{C}$ | 46 | A |
| $I_{DM}^{(1)}$ | Drain current (pulsed) | 260 | A |
| P_{TOT} | Total dissipation at $T_C = 25\text{ }^\circ\text{C}$ | 50 | W |
| | Derating factor | 0.3 | W/ $^\circ\text{C}$ |
| $E_{AS}^{(2)}$ | Single pulse avalanche energy | TBD | mJ |
| T_j T_{stg} | Operating junction temperature Storage temperature | -55 to 175 | $^\circ\text{C}$ |

1. Pulse width limited by safe operating area.

2. Starting $T_j = 25\text{ }^\circ\text{C}$, $I_d = 32.5\text{ A}$, $V_{dd} = 12\text{ V}$.

Table 3. Thermal resistance

| Symbol | Parameter | Value | Unit |
|----------------|--|-------|--------------------|
| $R_{thj-case}$ | Thermal resistance junction-case max | 3 | $^\circ\text{C/W}$ |
| $R_{thj-amb}$ | Thermal resistance junction-case max | 100 | $^\circ\text{C/W}$ |
| T_j | Maximum lead temperature for soldering purpose | 275 | $^\circ\text{C}$ |

2 Electrical characteristics

($T_{CASE} = 25\text{ °C}$ unless otherwise specified).

Table 4. Static

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|---------------|--|--|------|--------|-----------|--------------------------------|
| $V_{(BR)DSS}$ | Drain-source breakdown Voltage | $I_D = 250\ \mu\text{A}$, $V_{GS} = 0$ | 30 | | | V |
| I_{DSS} | Zero gate voltage drain current ($V_{GS} = 0$) | $V_{DS} = 30\text{ V}$ $V_{DS} = 30\text{ V}$, $T_c = 125\text{ °C}$ | | | 1 10 | μA μA |
| I_{GSS} | Gate body leakage current ($V_{DS} = 0$) | $V_{GS} = \pm 22\text{ V}$ | | | ± 100 | nA |
| $V_{GS(th)}$ | Gate threshold voltage | $V_{DS} = V_{GS}$, $I_D = 250\ \mu\text{A}$ | 1 | 1.8 | 3 | V |
| $R_{DS(on)}$ | Static drain-source on resistance | $V_{GS} = 10\text{ V}$, $I_D = 32.5\text{ A}$ SMD version | | 0.0061 | 0.0069 | Ω |
| | | $V_{GS} = 10\text{ V}$, $I_D = 32.5\text{ A}$ | | 0.0065 | 0.0073 | Ω |
| | | $V_{GS} = 4.5\text{ V}$, $I_D = 32.5\text{ A}$ SMD version | | 0.0084 | 0.0093 | Ω |
| | | $V_{GS} = 4.5\text{ V}$, $I_D = 32.5\text{ A}$ | | 0.0088 | 0.0097 | Ω |

Table 5. Dynamic

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------|------------------------------|--|------|------|------|----------|
| C_{iss} | Input capacitance | $V_{DS} = 25\text{ V}$, $f = 1\text{ MHz}$, $V_{GS} = 0$ | - | 1290 | - | pF |
| C_{oss} | Output capacitance | | | 240 | | pF |
| C_{rss} | Reverse transfer capacitance | | | 32 | | pF |
| Q_g | Total gate charge | $V_{DD} = 15\text{ V}$, $I_D = 65\text{ A}$ | - | 8 | - | nC |
| Q_{gs} | Gate-source charge | $V_{GS} = 4.5\text{ V}$ | | 3.6 | | nC |
| Q_{gd} | Gate-drain charge | (<i>Figure 14</i>) | | 3.4 | | nC |
| R_g | Intrinsic gate resistance | $f = 1\text{ MHz}$ Gate DC Bias = 0 test signal level = 20 mV open drain | | 1.7 | | Ω |

Table 6. Switching on/off (resistive load)

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------------|----------------------------------|--|------|-------------|------|----------|
| $t_{d(on)}$ t_r | Turn-on delay time Rise time | $V_{DD}=10\text{ V}$, $I_D=65\text{ A}$, $R_G=4.7\ \Omega$, $V_{GS}=10\text{ V}$ (<i>Figure 13</i> and <i>Figure 18</i>) | - | 8.6 11.2 | - | ns ns |
| $t_{d(off)}$ t_f | Turn-off delay time Fall time | $V_{DD}=10\text{ V}$, $I_D=25\text{ A}$, $R_G=4.7\ \Omega$, $V_{GS}=10\text{ V}$ (<i>Figure 13</i> and <i>Figure 18</i>) | - | 32.4 6 | - | ns ns |

Table 7. Source drain diode

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------------------------|--|---|------|-----------------|-----------|---------------|
| I_{SD} I_{SDM} | Source-drain current Source-drain current (pulsed) ⁽¹⁾ | | - | | 65 260 | A A |
| V_{SD} | Forward on voltage | $I_{SD}=32.5\text{ A}$, $V_{GS}=0$ | - | | 1.1 | V |
| t_{rr} Q_{rr} I_{RRM} | Reverse recovery time Reverse recovery charge Reverse recovery current | $I_{SD}=32.5\text{ A}$, $di/dt=100\text{ A}/\mu\text{s}$, $V_{DD}=20\text{ V}$, (<i>Figure 15</i>) | - | 22 15 1.4 | | ns nC A |

1. Pulsed: pulse duration = 300 μs , duty cycle 1.5%.

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

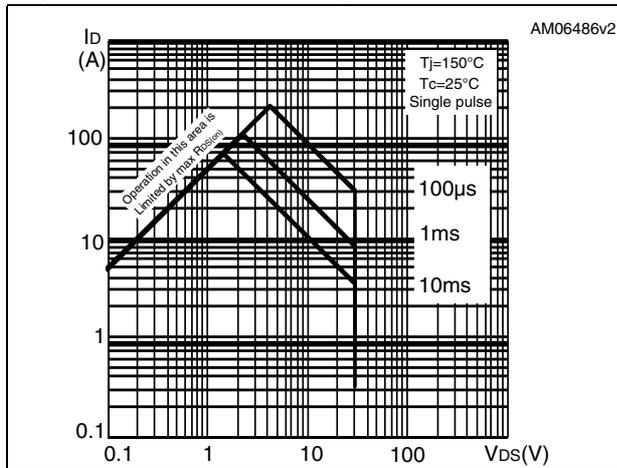


Figure 3. Thermal impedance

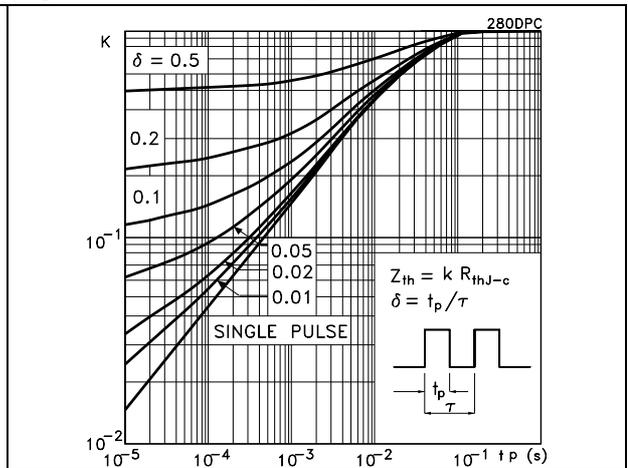


Figure 4. Output characteristics

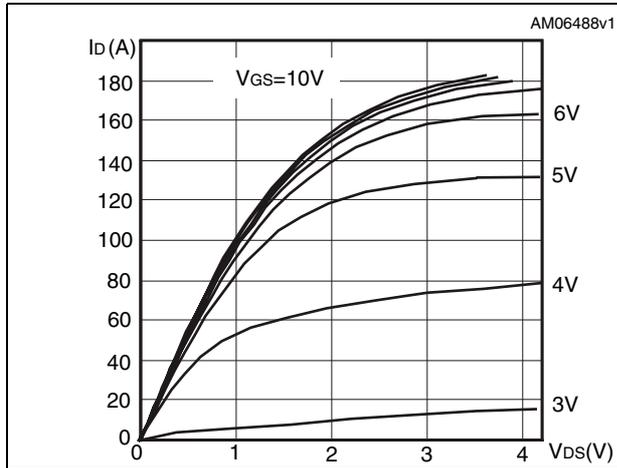


Figure 5. Transfer characteristics

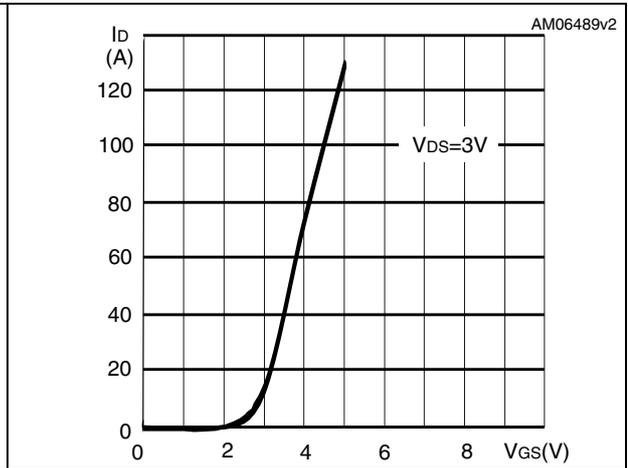


Figure 6. Normalized BV_{DSS} vs temperature

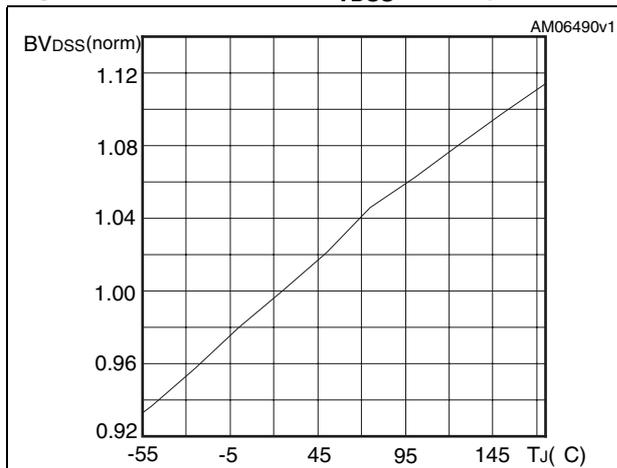


Figure 7. Static drain-source on resistance

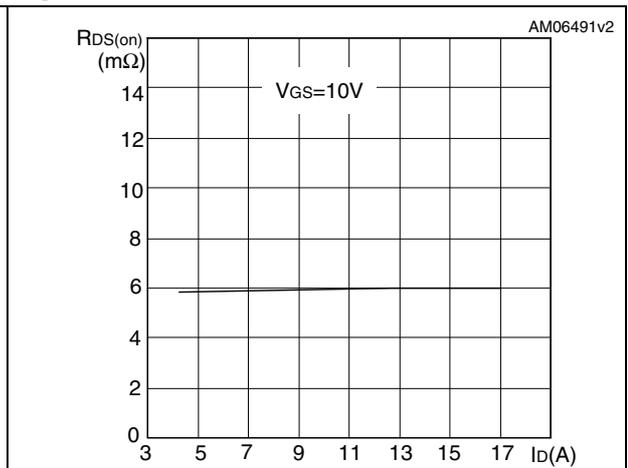


Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

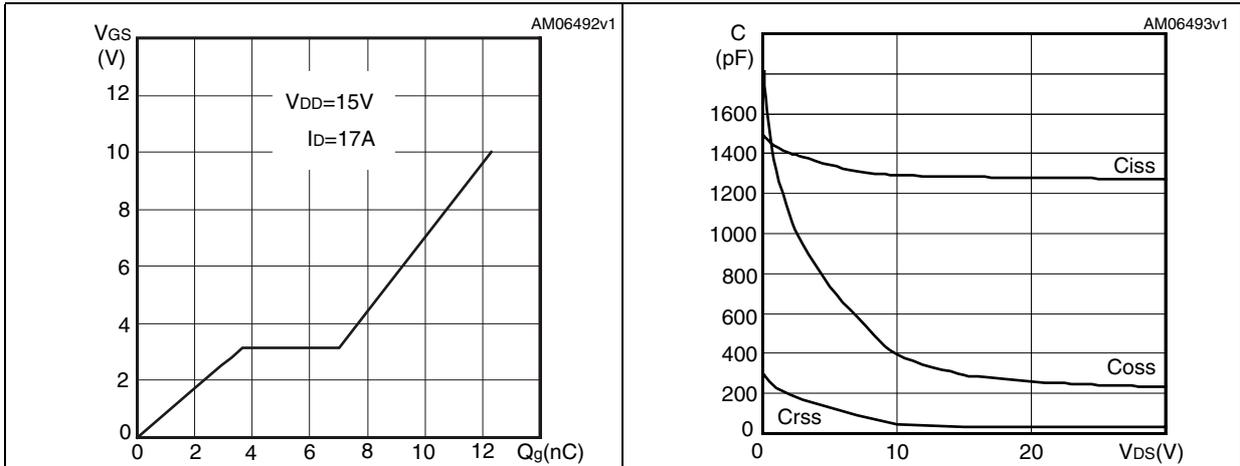


Figure 10. Normalized gate threshold voltage vs temperature Figure 11. Normalized on resistance vs temperature

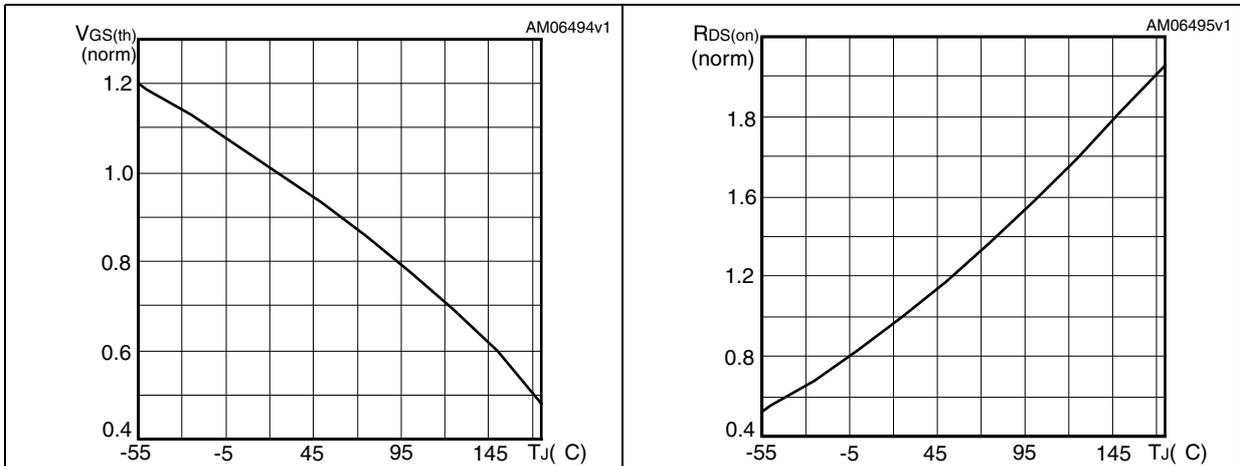
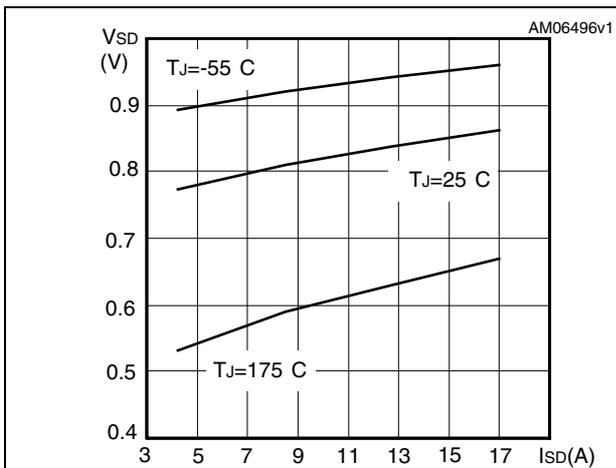
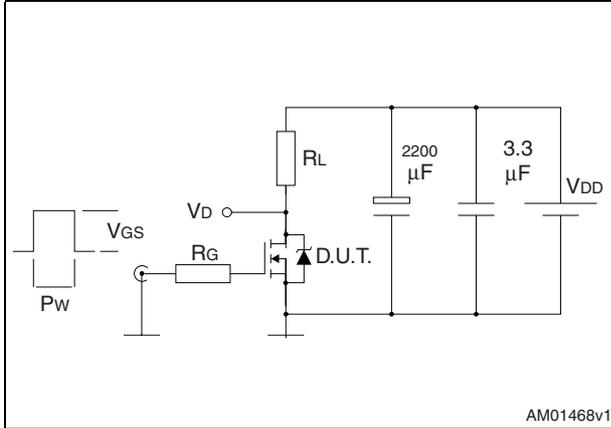


Figure 12. Source-drain diode forward characteristics



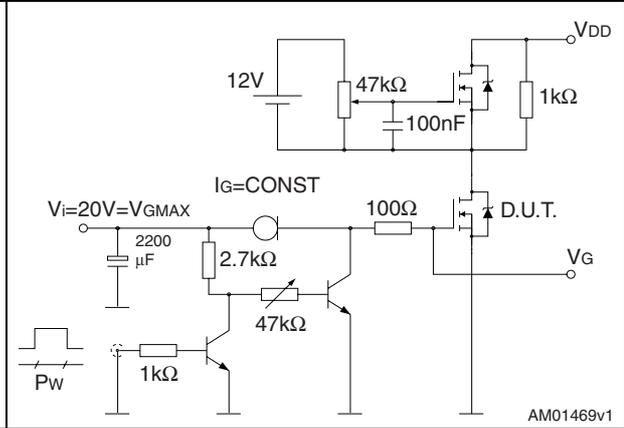
3 Test circuits

Figure 13. Switching times test circuit for resistive load



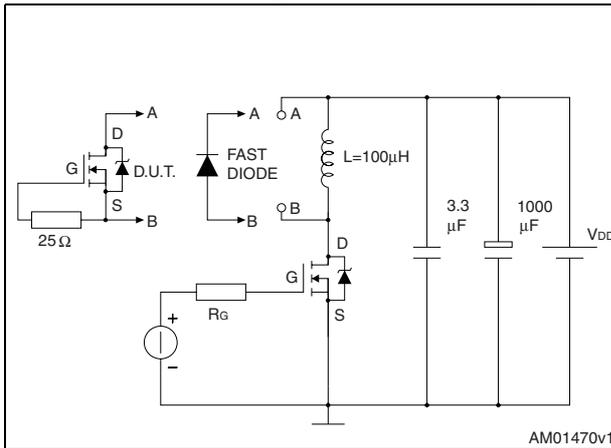
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Figure 14. Gate charge test circuit



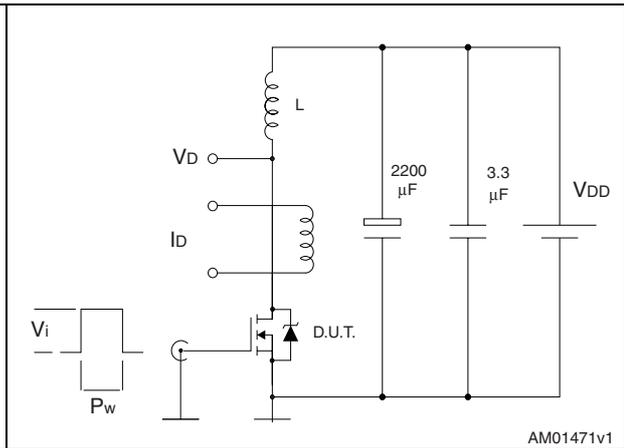
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Figure 15. Test circuit for inductive load switching and diode recovery times



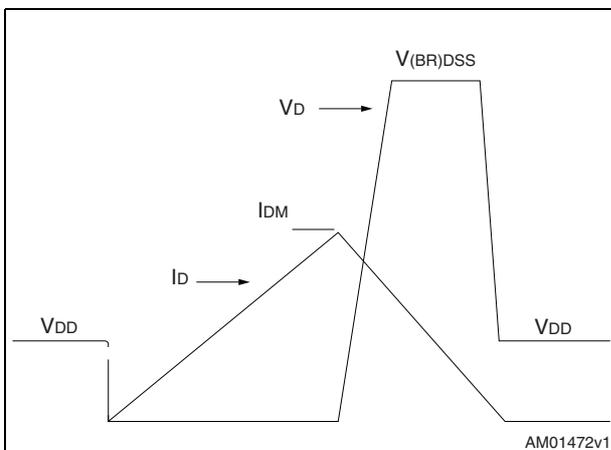
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Figure 16. Unclamped inductive load test circuit



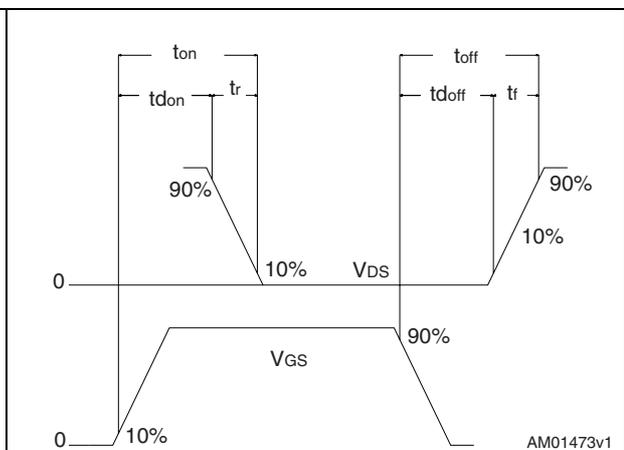
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Figure 17. Unclamped inductive waveform



AM01472v1

Figure 18. Switching time waveform



AM01473v1

4 Package mechanical data

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Figure 20. DPAK (TO-252) drawing

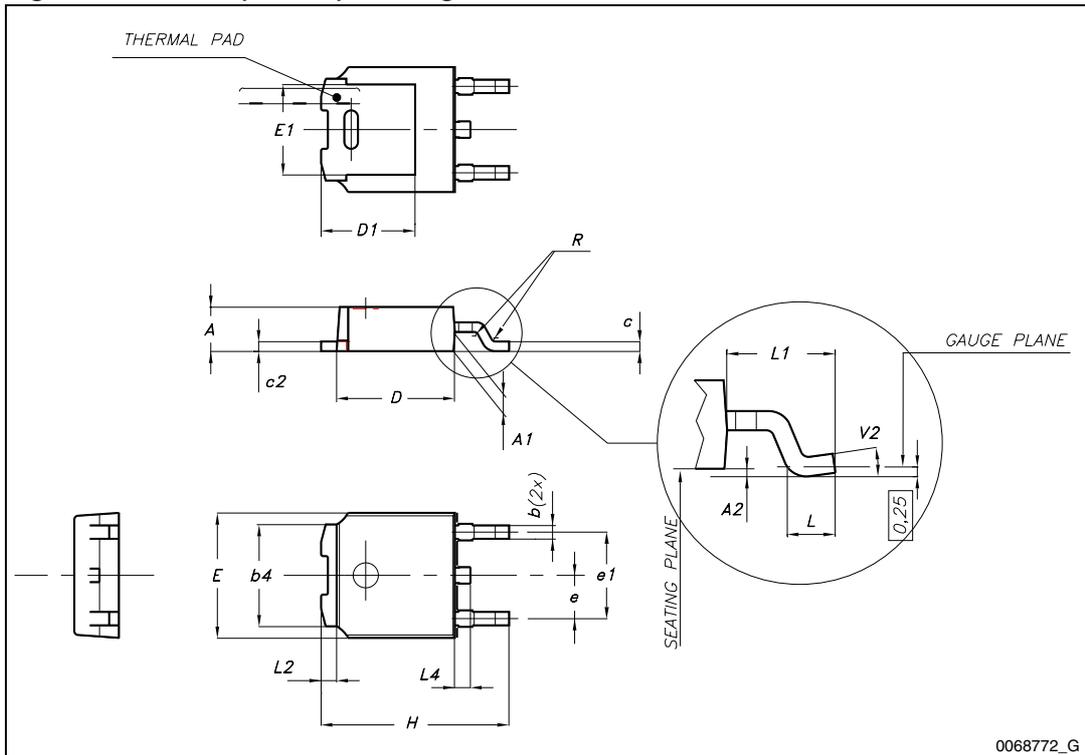
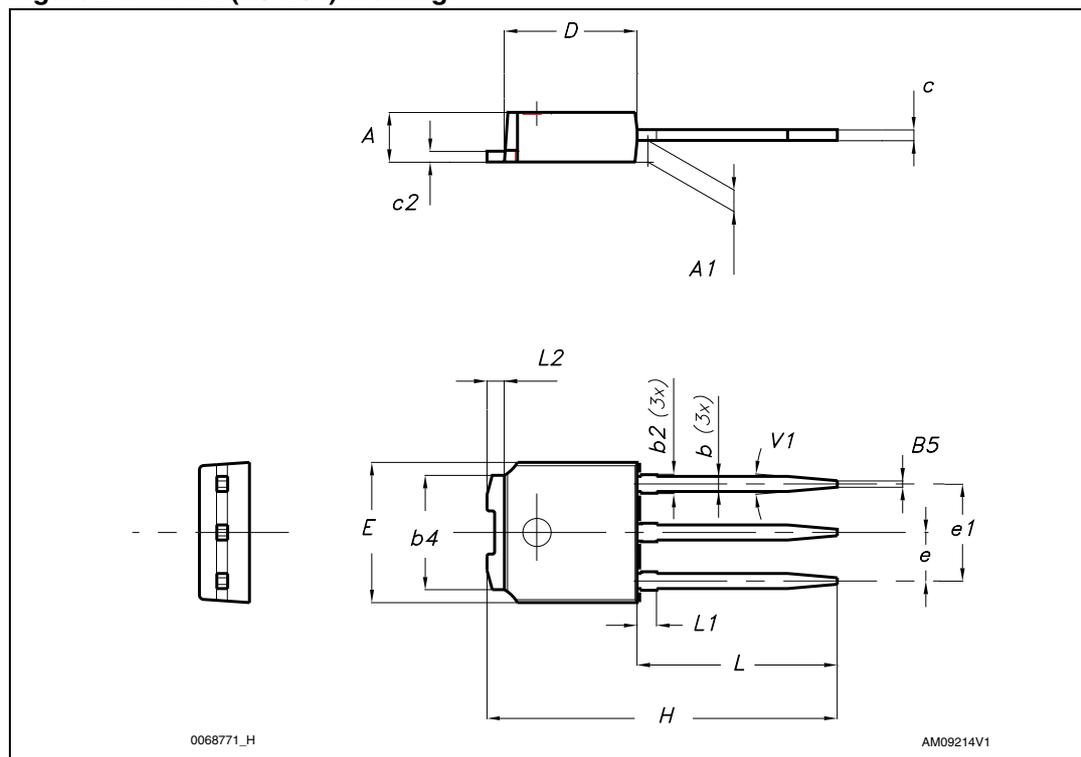


Table 9. IPAK (TO-251) mechanical data

| Dim. | mm. | | |
|------|------|-------|------|
| | Min. | Typ. | Max. |
| A | 2.20 | | 2.40 |
| A1 | 0.90 | | 1.10 |
| b | 0.64 | | 0.90 |
| b2 | | | 0.95 |
| b4 | 5.20 | | 5.40 |
| B5 | | 0.3 | |
| c | 0.45 | | 0.60 |
| c2 | 0.48 | | 0.60 |
| D | 6.00 | | 6.20 |
| E | 6.40 | | 6.60 |
| e | | 2.28 | |
| e1 | 4.40 | | 4.60 |
| H | | 16.10 | |
| L | 9.00 | | 9.40 |
| L1 | 0.80 | | 1.20 |
| L2 | | 0.80 | 1.00 |
| V1 | | 10° | |

Figure 21. IPAK (TO-251) drawing



5 Packaging mechanical data

Table 10. DPAK (TO-252) tape and reel mechanical data

| Tape | | | Reel | | |
|------|------|------|-----------|------|------|
| Dim. | mm | | Dim. | mm | |
| | Min. | Max. | | Min. | Max. |
| A0 | 6.8 | 7 | A | | 330 |
| B0 | 10.4 | 10.6 | B | 1.5 | |
| B1 | | 12.1 | C | 12.8 | 13.2 |
| D | 1.5 | 1.6 | D | 20.2 | |
| D1 | 1.5 | | G | 16.4 | 18.4 |
| E | 1.65 | 1.85 | N | 50 | |
| F | 7.4 | 7.6 | T | | 22.4 |
| K0 | 2.55 | 2.75 | | | |
| P0 | 3.9 | 4.1 | Base qty. | | 2500 |
| P1 | 7.9 | 8.1 | Bulk qty. | | 2500 |
| P2 | 1.9 | 2.1 | | | |
| R | 40 | | | | |
| T | 0.25 | 0.35 | | | |
| W | 15.7 | 16.3 | | | |

Figure 22. Tape for DPAK (TO-252)

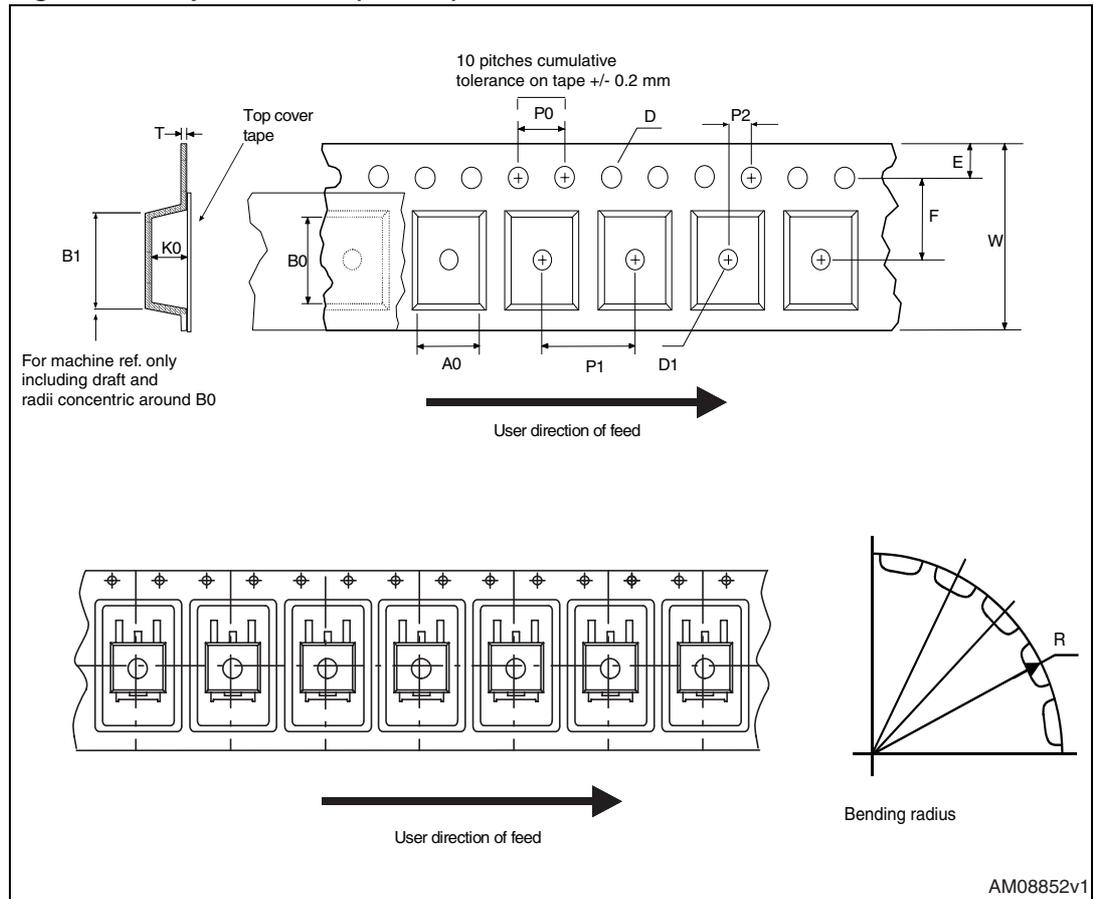
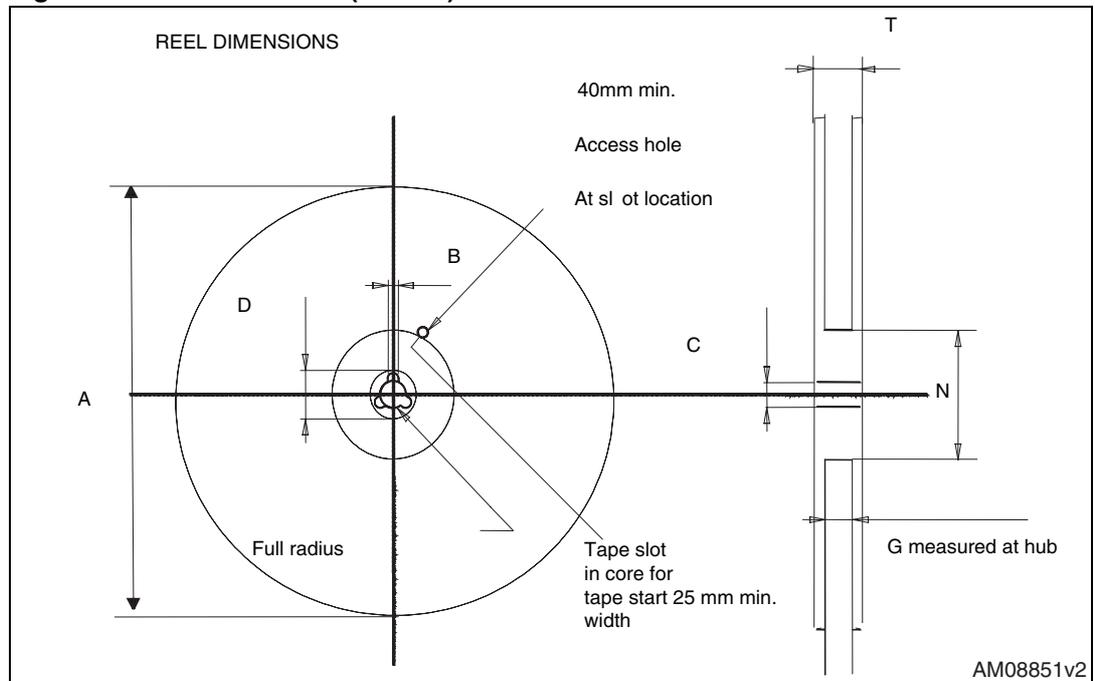


Figure 23. Reel for DPAK (TO-252)



6 Revision history

Table 11. Document revision history

| Date | Revision | Changes |
|-------------|----------|----------------|
| 19-May-2011 | 1 | First release. |

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